

Integrated Circuit Systems, Inc.

# ICS9169-01

## Frequency Generator and Integrated Buffers for Intel Pentium and Pentium Pro™ μP's

### **General Description**

The **ICS9169-01** generates all clocks required for high speed RISC or CISC microprocessor systems such as 486, Pentium/ Pentium Pro<sup>TM</sup>, PowerPC<sup>TM</sup>, etc. Four different reference frequency multiplying factors are externally selectable with smooth frequency transitions. These multiplying factors can be customized for specific applications. A test mode is provided to drive all clocks directly.

High drive BCLK outputs typically provide greater than 1V/ ns slew rate into 30pF loads. PCLK outputs typically provide better than 1V/ns slew rate into 20pF loads while maintaining  $50\pm5\%$  duty cycle. The REF clock outputs typically provide better than 0.5V/ns slew rates.

### **Features**

- Generates four processor, six bus, three 14.318 MHz and one 48 MHz clock for ISA bus, audio, super I/O and bus bridge devices
- Supports the Intel MARS chip set
- Synchronous clocks skew matched to 250ps window on PCLKs and 500ps window on BCLKs
- Test clock mode eases system design
- Selectable multiplying ratios
- Custom configurations available
- Output frequency ranges to 100 MHz (depending on option)
- 3.0V 5.5 V supply range
- 28-pin SOIC and 28-pin SSOP (209-mil) packages

## Applications

• Ideal for high-speed RISC or CISC systems such as 486, Pentium, Pentium Pro, PowerPC, etc.



## **Block Diagram**

ICS reserves the right to make changes in the device data identified in this publication without further notice. ICS advises its customers to obtain the latest version of all device data to verify that any information being relied upon by the customer is current and accurate.



## **Pin Configuration**



**Pin Descriptions** 

### Functionality

FS1	FS0	*VCO	X1, REF	PCLK(0:3)
			(MHz)	(MHz)
0	0	230/33x X1	14.31818	50 (49.7)
0	1	212/23x X1	14.31818	66 (66.5)
1	0	176/21x X1	14.31818	60 (59.9)
1	1	Test mode	TCLK	TCLK/2

\*VCO range is limited from 60 - 200 MHz

PCLK(0:3)	BCLK(0:5)	48 MHz
VCO/2	PCLK/2	48 MHz
TCLK/2	TCLK/4	TCLK/2

PIN NUMBER	PIN NAME	TYPE	DESCRIPTION
2	X1	IN	XTAL or external reference frequency input. This input includes XTAL load capacitance and feedback bias for a 12.16 MHz crystal, nominally 14.31818
3	X2	OUT	XTAL output which includes XTAL load capacitance.
4, 11, 23	GND	PWR	Ground for logic, PCLK and fixed frequency output buffers.
17	GND	PWR	Ground for BCLK output buffers.
1, 8, 26	VDD	PWR	Power for logic, PCLK and fixed frequency output buffers.
14, 20	VDD	PWR	Power for BCLK output buffers.
6, 7, 9, 10	PCLK(0:3)	OUT	Processor clock outputs which are a multiple of the input reference frequency as shown in the table above.
13, 12	FS(0:1)	IN	Frequency multiplier select pins. See table above. These inputs have internal pull-up devices.
15, 16, 18 19, 21, 22	BCLK(0:5)	OUT	Bus clock outputs are fixed at 1/2 the PCLK frequency.
5	OEN	IN	OEN tristates all outputs when low. This input has an internal pull-up device.
24	48MHz	OUT	Fixed 48 MHz clock (with 14.318 MHz input).
28, 27, 25	REF(0:2)	OUT	REF is a buffered copy of the crystal oscillator or reference input clock, nominally 14.31818 MHz.

**Note 1:** BCLK buffers cannot be supplied with 5 volts (pins 14 and 20) if CPU and fixed frequencies (pins 1, 8, and 26) are being supplied with 3.3 volts



## **Absolute Maximum Ratings**

Supply Voltage	
Logic Inputs	GND - 0.5 V to VDD + 0.5 V
Ambient Operating Temperature	0 to +70 C
Storage Temperature	-65 to +150 C

Stresses above those listed under *Absolute Maximum Ratings* may cause permanent damage to the device. These ratings are stess specifications only and functional operation of the device at these or any other conditions above those listed in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect product reliability.

## **Electrical Characteristics at 3.3 V**

DC Characteristics								
PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNITS		
Input Low Voltage	VIL		-	-	0.2Vdd	V		
Input High Voltage	Vih		0.7Vdd	-	-	V		
Input Low Current	IIL	$V_{\rm IN} = 0 V$	-28.0	-10.5	-	μΑ		
Input High Current	Іін	Vin = Vdd	-5.0	-	5.0	μΑ		
Output Low Current <sup>1</sup>	Iol	$V_{OL} = 0.8 V;$ for PCLKs & BCLKs	30.0	47.0	-	mA		
Output High Current <sup>1</sup>	Іон	Vol = 2.0 V; for PCLKs & BCLKs	-	-66.0	-42.0	mA		
Output Low Current <sup>1</sup>	Iol	V <sub>CL</sub> =0.8V; for fixed CLKs	25.0	38.0	-	mA		
Output High Current <sup>1</sup>	Іон	VoL=2.0V; for fixed CLKs	-	-47.0	-30.0	mA		
Output Low Voltage <sup>1</sup>	Vol	IoL = 15 mA; for PCLKs & BCLKs	-	0.3	0.4	V		
Output High Voltage <sup>1</sup>	Vон	Iон = -30 mA; for PCLKs & BCLKs	2.4	2.8	-	v		
Output Low Voltage <sup>1</sup>	Vol	IoL=12.5mA; for fixed CLKs	-	0.3	0.4	V		
Output High Voltage <sup>1</sup>	Vон	Iон = -20mA; for fixed CLKs	2.4	2.8	-	V		
Supply Current	Idd	@ 66.5 MHz; all outputs unloaded	-	55	110	mA		

Note 1: Parameter is guaranteed by design and characterization. Not 100% tested in production.

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## **Electrical Characteristics at 3.3 V**

 $V_{DD}\,{=}\,3.0$  - 3.7 V,  $T_A\,{=}\,0$  -  $70^oC$  unless otherwise stated

AC Characteristics								
PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNITS		
Rise Time <sup>1</sup>	Tr1	20pF load, 0.8 to 2.0V PCLK & BCLK	-	0.9	1.5	ns		
Fall Time <sup>1</sup>	Tf1	20pF load, 2.0 to 0.8V PCLK & BCLK	-	0.8	1.4	ns		
Rise Time <sup>1</sup>	Tr2	20pF load, 20% to 80% PCLK & BCLK	-	1.5	2.5	ns		
Fall Time <sup>1</sup>	Tf2	20pF load, 80% to 20% PCLK & BCLK	-	1.4	2.4	ns		
Duty Cycle <sup>1</sup>	Dt	20pF load @ Vout = 1.4 V	45	50	55	%		
Jitter, One Sigma <sup>1</sup>	Tj1s1	PCLK & BCLK Clocks; Load=20pF, FOUT >25 MHz	-	50	150	ps		
Jitter, Absolute <sup>1</sup>	Tjab1	PCLK & BCLK Clocks; Load=20pF, F <sub>OLT</sub> >25 MHz	-250	-	250	ps		
Jitter, One Sigma <sup>1</sup>	Tj1s2	Fixed CLK; Load=20pF	-	1	3	%		
Jitter, Absolute <sup>1</sup>	Tjab2	Fixed CLK; Load=20pF	-5	2	5	%		
Input Frequency <sup>1</sup>	Fj		12.0	14.318	16.0	MHz		
Logic Input Capacitance <sup>1</sup>	Cin	Logic input pins	-	5	-	pF		
Crystal Oscillator Capacitance <sup>1</sup>	Cinx	X1, X2 pins	-	18	-	pF		
Power-on Time <sup>1</sup>	ton	From VDD=1.6V to 1st crossing of 66.5 MHz VDD supply ramp < 40 ms	-	2.5	4.5	ms		
Frequency Settling Time <sup>1</sup>	ts	From 1st crossing of acquisition to $< 1\%$ settling	-	2.0	4.0	ms		
Clock Skew Window <sup>1</sup>	Tsk1	PCLK to PCLK; Load=20pF; @1.4V	-	150	250	ps		
Clock Skew Window <sup>1</sup>	Tsk2	BCLK to BCLK; Load=20pF; @1.4V	-	300	500	ps		
Clock Skew Window <sup>1</sup>	Tsk3	PCLK to BCLK; Load=20pF; @1.4V	1	2.6	5	ns		

Note 1: Parameter is guaranteed by design and characterization. Not 100% tested in production.



## **Electrical Characteristics at 5.0 V**

 $V_{DD}$  = 4.5 - 5.5 V,  $T_A \!=\,$  0 - 70  $^o\!C$  unless otherwise stated

DC Characteristics								
PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNITS		
Input Low Voltage	Vil		-	-	0.8	V		
Input High Voltage	VIH		2.4	-	-	V		
Input Low Current	IIL	$V_{IN} = 0 V$	-45	-15	-	μΑ		
Input High Current	Іін	$V_{IN} = V_{DD}$	-5.0	-	5.0	μΑ		
Output Low Current <sup>1</sup>	Iol	VoL = 0.8 V; for PCLKs & BCLKs	36.0	62.0	-	mA		
Output High Current <sup>1</sup>	Іон	VoL = 2.0 V; for PCLKs & BCLKs	-	-152	-90.0	mA		
Output Low Current <sup>1</sup>	Iol	$V_{OL} = 0.8V$ ; for fixed CLKs	30.0	50.0	-	mA		
Output High Current <sup>1</sup>	Іон	VoL=2.0V; for fixed CLKs	-	-110.0	-65.0	mA		
Output Low Voltage <sup>1</sup>	Vol	IoL = 20 mA; for PCLKs & BCLKs	-	0.25	0.4	V		
Output High Voltage <sup>1</sup>	Vон	Iон = -70 mA; for PCLKs & BCLKs	2.4	4.0	-	V		
Output Low Voltage <sup>1</sup>	Vol	IOL = 15mA; for fixed CLKs	-	0.2	0.4	V		
Output High Voltage <sup>1</sup>	Voh	Iон=-50mA; for fixed CLKs	2.4	4.7	-	V		
Supply Current <sup>1</sup>	Idd	@ 66.5 MHz; all outputs unloaded	-	80.0	160.0	mA		

Note 1: Parameter is guaranteed by design and characterization. Not 100% tested in production.

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#### **General Layout Precautions:**

- 1) Use a ground plane on the top layer of the PCB in all areas not used by traces.
- 2) Make all power traces and vias as wide as possible to lower inductance.



= Solder Pads

- Notes:
- 1) All clock outputs should have series terminating resistor. Not shown in all places to improve readibility of diagram.
- 2) 47 ohm / 56pf RC termination should be used at 50MHz and higher clock loads.
- 3) Optional crystal load capacitors are recommended.

#### **Capacitor Values:**

C1, C2 : Crystal load values determined by user

C3:100pF ceramic

All unmarked capacitors are 0.01µF ceramic

#### Connections to VDD:





## **Electrical Characteristics at 5.0 V**

 $V_{DD} = 4.5 - 5.5 \text{ V}, T_A = 0 - 70 \text{ }^{o}\text{C}$  unless otherwise stated

T		AC Characteristics	1			
PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNITS
Rise Time <sup>1</sup>	Tr1	20pF load, 0.8 to 2.0V PCLK & BCLK	-	0.55	0.95	ns
Fall Time <sup>1</sup>	Tf1	20pF load, 2.0 to 0.8V PCLK & BCLK	-	0.52	0.90	ns
Rise Time <sup>1</sup>	Tr2	20pF load, 20% to 80% PCLK & BCLK	-	1.2	2.1	ns
Fall Time <sup>1</sup>	Tf2	20pF load, 80% to 20% PCLK & BCLK	-	1.1	2.0	ns
Duty Cycle <sup>1</sup>	Dt1	20pF load @ VOUT = 50% of VDD	45	50	55	%
Duty Cycle <sup>1</sup>	Dt2	20pF load @ VOUT = 1.4 V	50	55	60	%
Jitter, One Sigma <sup>1</sup>	Tj1s1	PCLK & BCLK Clocks; Load=20pF; R=33 $\Omega$ Fout > 25 MHz			150	ps
Jitter, Absolute <sup>1</sup>	Tjab1	PCLK & BCLK Clocks; Load=20pF; R=33 Ω Fout > 25 MHz	-250	-	250	ps
Jitter, One Sigma <sup>1</sup>	Tjis2	Fixed CLK; Load=20pF R=33 Ω	-	1	3	%
Jitter, Absolute <sup>1</sup>	Tjab2	Fixed CLK; Load=20pF R=33 Ω	-5	2	5	%
Input Frequency <sup>1</sup>	Fi		12.0	14.318	16.0	MHz
Logic Input Capacitance <sup>1</sup>	Cin	Logic input pins	-	5	-	pF
Crystal Oscillator Capacitance <sup>1</sup>	Cinx	X1, X2 pins	-	18	-	pF
Power-on Time <sup>1</sup>	ton	From V=1.6V to 1st crossing of 66.5 MHz VDD supply ramp < 40 ms	-	2.5	4.5	ms
Frequency Settling Time <sup>1</sup>	ts	From 1st crossing of acquisition to < 1% settling	-	2.0	4.0	ms
Clock Skew Window <sup>1</sup>	Tsk1	PCLK to PCLK; Load=20pF; @1.4V	-	150	250	ps
Clock Skew Window <sup>1</sup>	Tsk2	BCLK to BCLK; Load=20pF; @1.4V	-	300	500	ps
Clock Skew Window <sup>1</sup>	Tsk3	PCLK to BCLK; Load=20pF; @1.4V	1	2.6	5	ns

Note 1: Parameter is guaranteed by design and characterization. Not 100% tested in production.

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**SOIC Package** 

## **Ordering Information**

#### ICS9169M-01

Example:









SSOP Package



SYMBOL	COMMO	COMMON DIMENSIONS			NOTE	4			6
				NOTE	VARIATIONS		D		
	MIN.	NOM.	MAX.			MIN.	NOM.	MAX.	
А	0.68	0.73	0.78		AA	0.239	0.244	0.249	14
А	0.002	0.005	0.008		AB	0.239	0.244	0.249	16
А	0.066	0.068	0.070		AC	0.278	0.284	0.289	20
В	0.010	0.012	0.015		AD	0.318	0.323	0.328	24
С	0.005	0.006	0.008		AE	0.397	0.402	0.407	28
D	See	See Variations			AF	0.397	0.402	0.407	30
Е	0.205	0.209	0.212	4					
e		0.0256 BSC							
Н	0.301	0.307	0.311						
L	0.022	0.030	0.037	5	1				
N	See Variations			6	1				
	0	4	8		1				

## Package dimensions - SSOP package

Table dimensions in inches

## **Ordering Information**

Example:

